

Low Skew Output Buffer

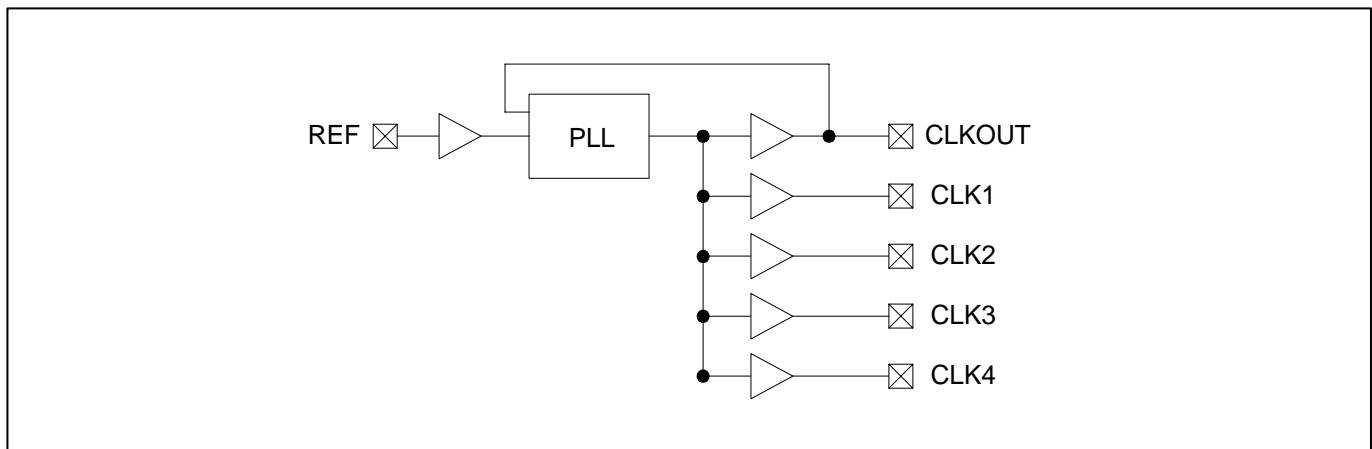
FEATURES

- Frequency range 50 ~ 120MHz.
- Internal phase locked loop will allow spread spectrum modulation on reference clock to pass to the outputs (up to 100kHz SST modulation).
- Zero input - output delay.
- Less than 700 ps device - device skew.
- Less than 250 ps skew between outputs.
- Less than 200 ps cycle - cycle jitter.
- Output Enable function tri-state outputs.
- 3.3V operation.
- Available in 8-Pin 150mil SOIC.

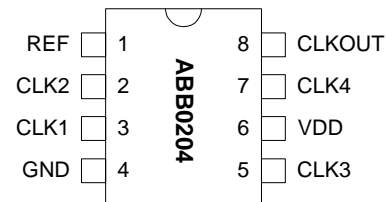
DESCRIPTION

The ABB0204 is a high performance, low skew, low jitter zero delay buffer designed to distribute high speed clocks and is available in 8-pin SOIC package. It has four outputs that are synchronized with the input. The synchronization is established via CLKOUT feed back to the input of the PLL. Since the skew between the input and output is less than ± 350 ps, the device acts as a zero delay buffer.

BLOCK DIAGRAM



PIN CONFIGURATION



Remark

If REF clock is stopped for more than 10 μ s after it has already been provided to the chip, and after power-up, the output clocks will disappear. In that instance, a full power-up reset is required in order to reactivate the output clocks.

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PIN DESCRIPTIONS

Name	Number	Type	Description
REF ¹	1	I	Input reference frequency. Spread spectrum modulation on this signal will be passed to the output (up to 100kHz SST modulation).
CLK2 ²	2	O	Buffered clock output.
CLK1 ²	3	O	Buffered clock output.
GND	4	P	Ground.
CLK3 ²	5	O	Buffered clock output.
VDD	6	P	3.3V Power Supply.
CLK4 ²	7	O	Buffered clock output.
CLKOUT ²	8	O	Buffered clock output. Internal feed back on this pin.

Notes: 1: Weak pull-down. 2: Weak pull-down on all outputs.

ELECTRICAL SPECIFICATIONS

1. Absolute Maximum Ratings

PARAMETERS	SYMBOL	MIN.	MAX.	UNITS
Supply Voltage	V _{DD}		4.6	V
Input Voltage, dc	V _I	-0.5	V _{DD} +0.5	V
Output Voltage, dc	V _O	-0.5	V _{DD} +0.5	V
Storage Temperature	T _S	-65	150	°C
Ambient Operating Temperature*	T _A	-40	85	°C
Junction Temperature	T _J		125	°C
Lead Temperature (soldering, 10s)			260	°C
ESD Protection, Human Body Model			2	kV

Exposure of the device under conditions beyond the limits specified by Maximum Ratings for extended periods may cause permanent damage to the device and affect product reliability. These conditions represent a stress rating only, and functional operations of the device at these or any other conditions above the operational limits noted in this specification is not implied.

* Note: Operating Temperature is guaranteed by design for all parts (COMMERCIAL and INDUSTRIAL), but tested for COMMERCIAL grade only.

2. Electrical Characteristics

PARAMETERS	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Supply Voltage	V _{DD}		2.97		3.63	V
Input Low Voltage	V _{IL}				0.8	V
Input High Voltage	V _{IH}		2.0			V
Input Low Current	I _{IL}	V _{IN} = 0V		19	50.0	μA
Input High Current	I _{IH}	V _{IN} = V _{DD}		0.10	100.0	μA
Output Low Voltage	V _{OL}	I _{OL} = 50mA		0.25	0.4	V
Output High Voltage	V _{OH}	I _{OH} = 50mA	2.4	2.9		V
Power Down Supply Current	I _{DD}	REF = 0MHz		0.3	50.0	μA
Supply Current	I _{DD}	Unloaded outputs at 133MHz, SEL inputs at V _{DD} or GND		35	45	mA

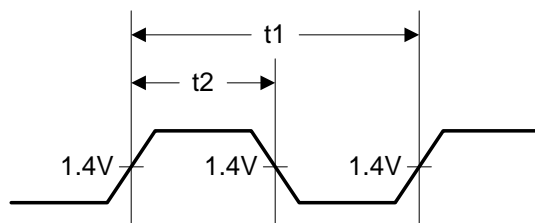
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3. Switching Characteristics

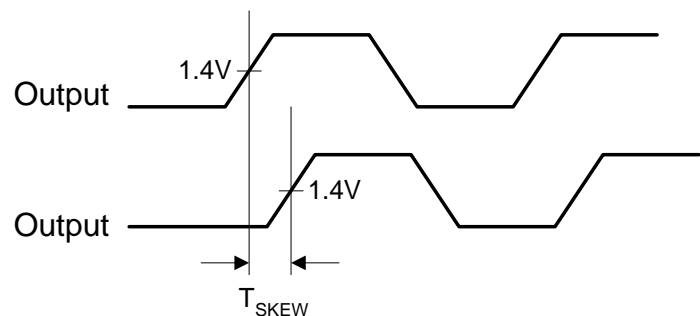
PARAMETERS	SYMBOL	DESCRIPTION	MIN.	TYP.	MAX.	UNITS
Output Frequency	t_1		50		120	MHz
Duty Cycle ($t_2 \div t_1$)	Dt1	Measured at 1.4V, $C_L=30\text{pF}$, $F_{\text{out}} = 66.67\text{MHz}$	40.0	50.0	60.0	%
Duty Cycle ($t_2 \div t_1$)	Dt2	Measured at 1.4V	45.0	50.0	55.0	%
Rise Time	T_r	Measured between 0.8V and 2.0V, $C_L=30\text{pF}$		1.2	1.5	ns
Fall Time	T_f	Measured between 2.0V and 0.8V, $C_L=30\text{pF}$		1.2	1.5	ns
Output to Output Skew	T_{skew}	All outputs equally loaded, $C_L=20\text{pF}$			250	ps
Delay, REF Rising Edge to CLKOUT Rising Edge	T_{delay}	Measured at 1.4V		0	± 350	ps
Device to Device Skew	$T_{\text{dsk-dsk}}$	Measured at $V_{\text{DD}}/2$ on the CLKOUT pins of devices		0	700	ps
Cycle to Cycle Jitter	$T_{\text{cyc-cyc}}$	Measured at 66.67MHz, loaded outputs			150	ps
PLL Lock Time	T_{lock}	Stable power supply, valid clock presented on REF pin			1.0	ms
Jitter; Absolute Jitter	T_{jabs}	At 10,000 cycles, $C_L=30\text{pF}$		70	100	ps
Jitter; 1-sigma	$T_{\text{j1-s}}$	At 10,000 cycles, $C_L=30\text{pF}$		10	20	ps

SWITCHING WAVEFORMS

Duty Cycle Timing

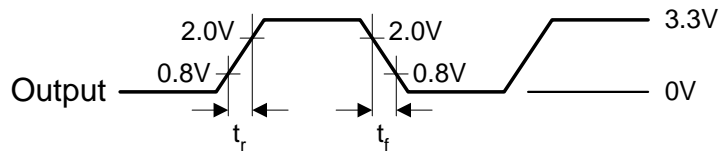


Output - Output Skew

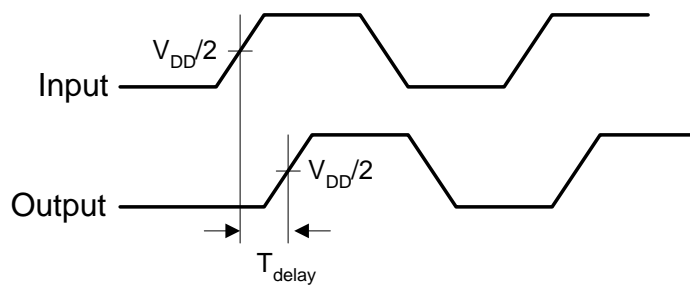


SWITCHING WAVE FORMS

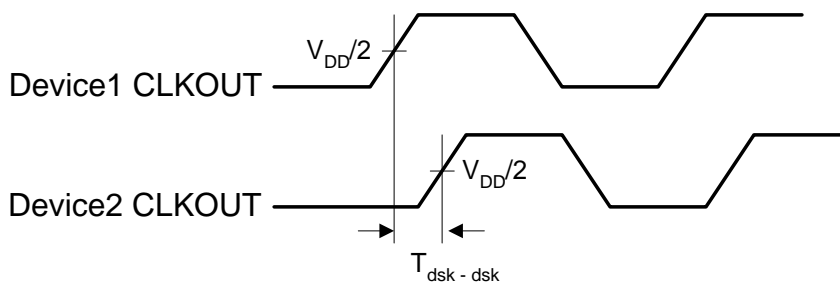
All Outputs Rise/Fall Time



Input to Output Propagation Delay



Device to Device Skew



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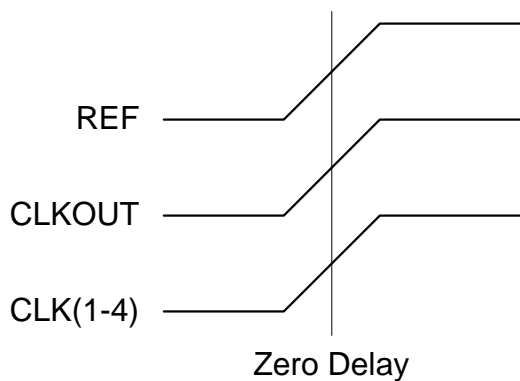
Output-Output Skew

The skew between CLKOUT and the CLK(1-4) outputs is not dynamically adjusted by the PLL. Since CLKOUT is one of the inputs to the PLL, zero phase difference is maintained from REF to CLKOUT. If all outputs are equally loaded, zero phase difference will be maintained from REF to all outputs.

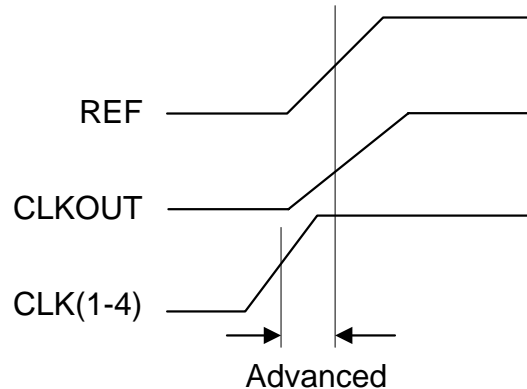
If applications requiring zero output-output skew, all the outputs must be equally loaded.

If the CLK(1-4) outputs are less loaded than CLKOUT, CLK(1-4) outputs will lead it; if the CLK(1-4) is more loaded than CLKOUT, CLK(1-4) will lag the CLKOUT.

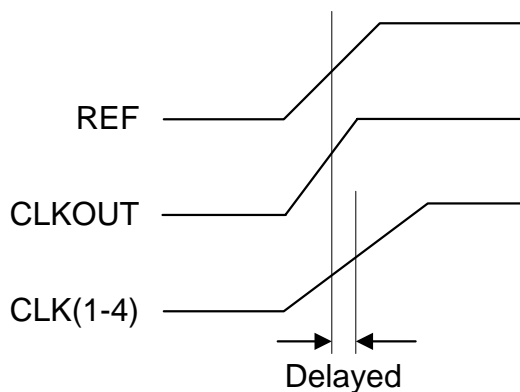
Since the CLKOUT and the CLK(1-4) outputs are identical, they all start at the same time, but difference loads cause them to have different rise times and different times crossing the measurement thresholds.



REF input and all outputs loaded equally



REF input and CLK(1-4) outputs loaded equally, with CLK(1-4) less loaded than CLKOUT.



REF input and CLK(1-4) outputs loaded equally, with CLK(1-4) more loaded than CLKOUT.

